

2SK2529 Silicon N Channel MOS FET

REJ03G1014-0800 (Previous: ADE-208-356F) Rev.8.00 Sep 07, 2005

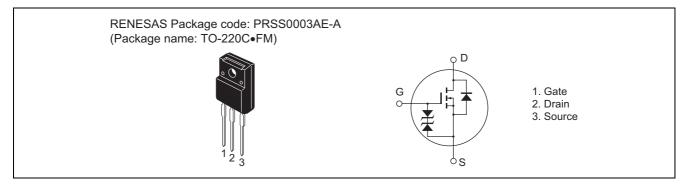
Application

High speed power switching

Features

- Low on-resistance
- $R_{DS(on)} = 7 \text{ m}\Omega \text{ typ.}$
- High speed switching
- 4 V gate drive device can be driven from 5 V source

Outline





Absolute Maximum Ratings

| | | | $(Ta = 25^{\circ}C)$ |
|---|--------------------------------------|-------------|----------------------|
| Item | Symbol | Ratings | Unit |
| Drain to source voltage | V _{DSS} | 60 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | ID | 50 | А |
| Drain peak current | I _{D(pulse)} * ¹ | 200 | А |
| Body to drain diode reverse drain current | I _{DR} | 50 | А |
| Avalanche current | I _{AP} * ³ | 45 | А |
| Avalanche energy | E _{AR} * ³ | 174 | mJ |
| Channel dissipation | Pch* ² | 35 | W |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1 \ \%$

2. Value at Tc = 25°C

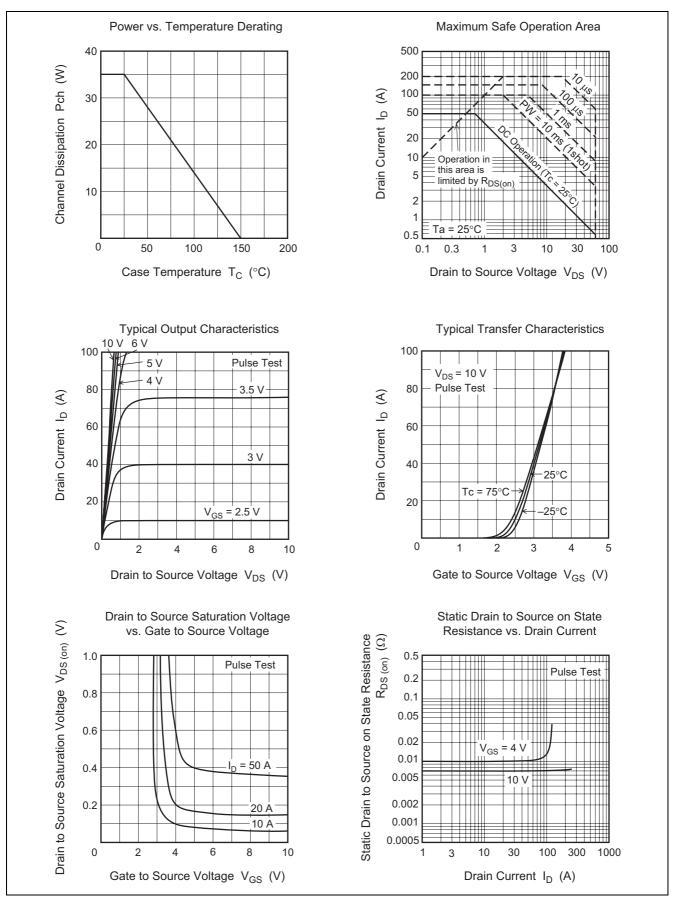
3. Value at Tch = 25°C, Rg \geq 50 Ω

Electrical Characteristics

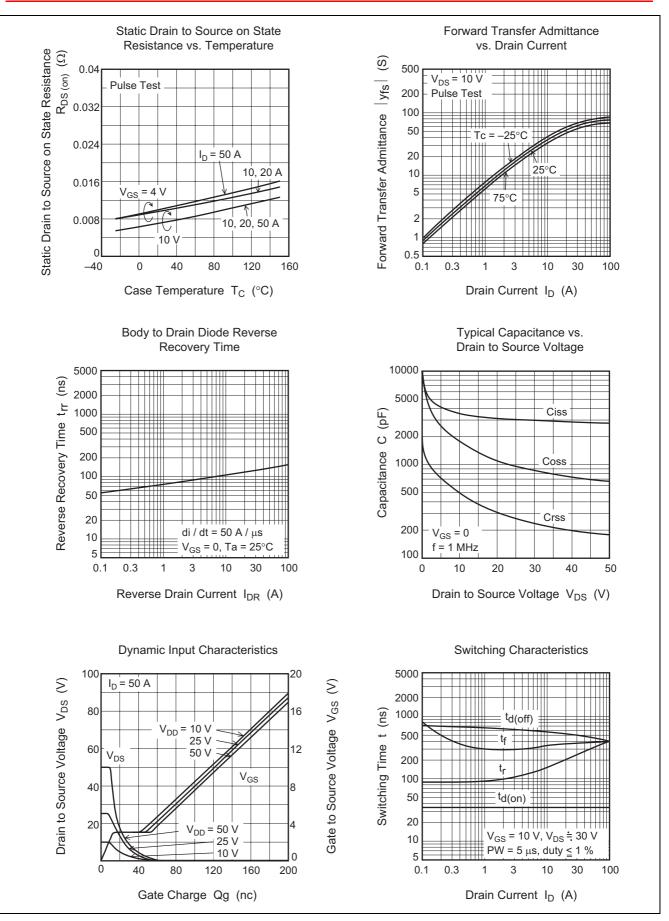
| | | | | | | $(Ta = 25^{\circ}C)$ |
|-------------------------------------|----------------------|-----|------|-----|------|--|
| ltem | Symbol | Min | Тур | Мах | Unit | Test Conditions |
| Drain to source breakdown voltage | V _{(BR)DSS} | 60 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | V _{(BR)GSS} | ±20 | — | — | V | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | — | — | ±10 | μA | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | | — | 10 | μΑ | $V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0$ |
| Gate to source cutoff voltage | V _{GS(off)} | 1.0 | — | 2.0 | V | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$ |
| Static drain to source on state | R _{DS(on)} | | 7 | 10 | mΩ | $I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{*4}$ |
| resistance | | | 10 | 16 | mΩ | $I_D = 25 \text{ A}, V_{GS} = 4 \text{ V}^{*4}$ |
| Forward transfer admittance | y _{fs} | 35 | 55 | — | S | $I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{*4}$ |
| Input capacitance | Ciss | | 3550 | — | pF | $V_{DS} = 10 \text{ V}, V_{GS} = 0,$ f = 1 MHz |
| Output capacitance | Coss | _ | 1760 | — | pF | |
| Reverse transfer capacitance | Crss | | 500 | — | pF | |
| Turn-on delay time | t _{d(on)} | | 35 | — | ns | $I_D = 25 \text{ A}, V_{GS} = 10 \text{ V},$ $R_L = 1.2 \Omega$ |
| Rise time | tr | | 230 | — | ns | |
| Turn-off delay time | t _{d(off)} | | 470 | — | ns | |
| Fall time | t _f | | 360 | — | ns | |
| Body to drain diode forward voltage | V _{DF} | | 0.85 | _ | V | $I_F = 50 \text{ A}, V_{GS} = 0$ |
| Body to drain diode reverse | t _{rr} | | 135 | _ | ns | $I_F = 50 \text{ A}, V_{GS} = 0$ |
| recovery time | | | | | | di _F / dt = 50 A / μs |

Note: 4. Pulse Test

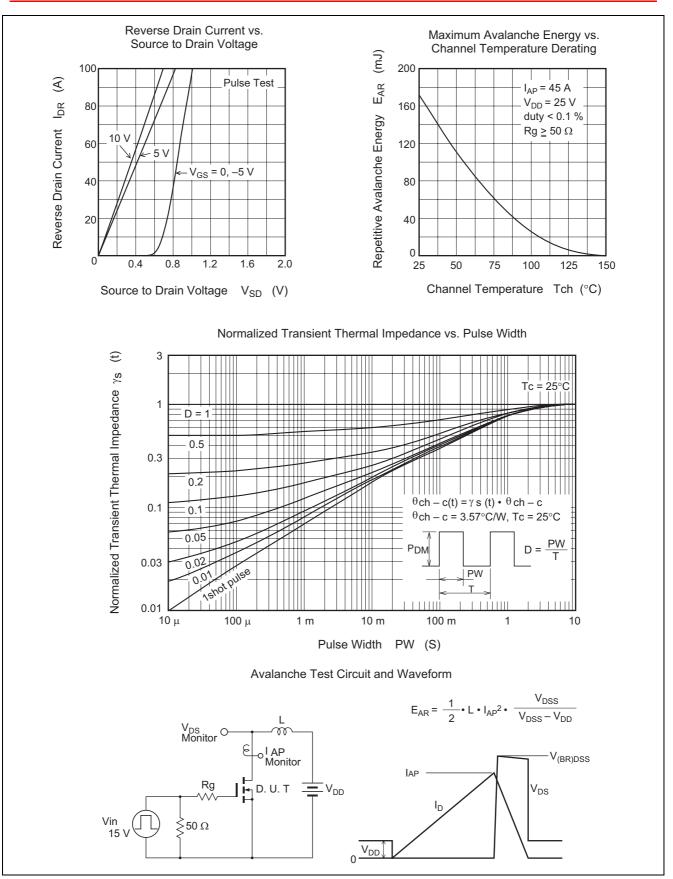
Main Characteristics

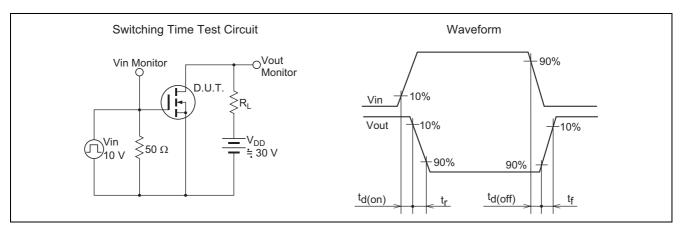






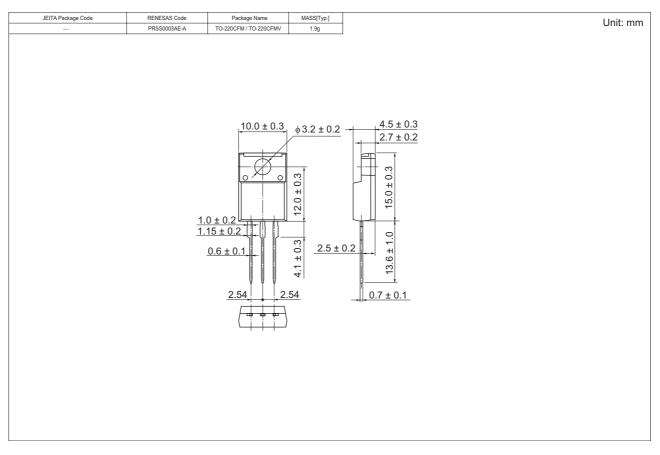








Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container |
|-----------|----------|--------------------|
| 2SK2529-E | 50 pcs | Plastic magazine |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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